PLEASE ENTER

PATTERSON &
SHERIDAN, LLP
ATTORNEYS AT LAW

RECEIVED CENTRAL FAX CENTER

FEB 2 1 2006

3040 Post Oak Blvd, Suite 1500 Hauston, TX 77056-6582 TEL 713.623.4844 FAX 713.623.4846

FACSIMILE COVER SHEET

DATE:

February 21, 2006

FILE NO:

APPM/008461PPC/CMP/CKIM

TO:

MAIL STOP AF

FAX NO:

571-273-8300

COMPANY:

USPTO

FROM:

Keith M. Tackett

PAGE(S) with cover:

11

ORIGINAL TO

FOLLOW?

☐ YES 図 NO

RESPONSE TO FINAL OFFICE ACTION DATED DECEMBER 20, 2005

TITLE:

Method and Apparatus for Infilm Defect Reduction for

Electrochemical Copper Deposition

U.S. SERIAL NO.:

10/774,194

FILING DATE:

February 5, 2004

INVENTOR:

Huang

EXAMINER:

Quovaunda Jefferson

GROUP ART UNIT:

2823

CONFIRMATION NO.:

6951

CONFIDENTIALITY NOTE

The document accompanying this facsimile transmission contains information from the law firm of Patterson & Sheridan, L.L.P. which is confidential or privileged. The information is intended to be for the use of the individual or entity named on this transmission sheet. If you are not the intended recipient, be aware that any disclosure, copying, distribution or use of the contents of this faxed information is prohibited. If you have received this faxsimile in error, please notify us by telephone immediately so that we can arrange for the retrieval of the original documents at no cost to you.

439939_1